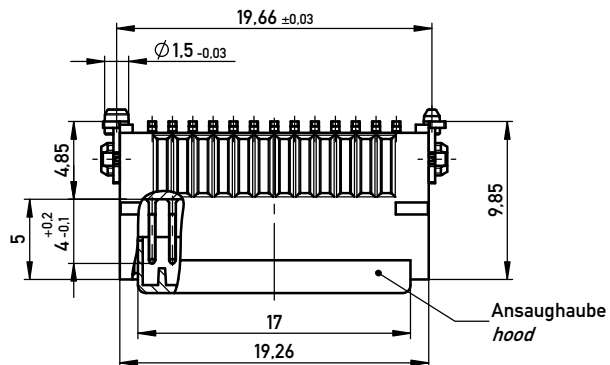
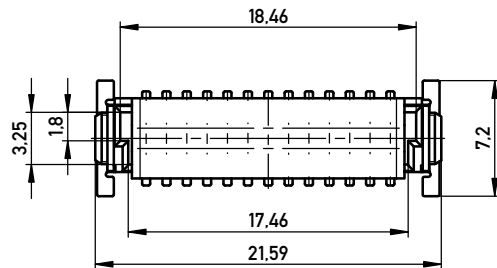
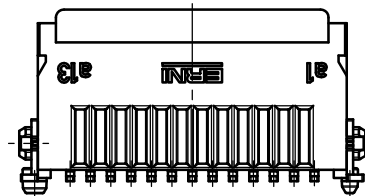
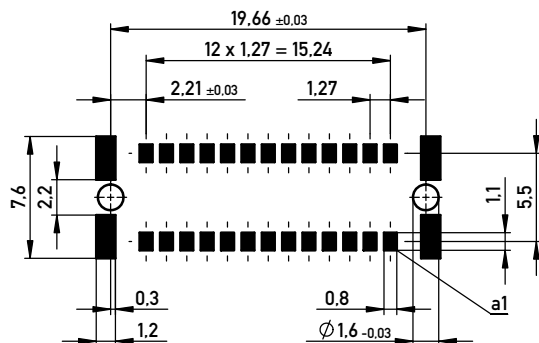
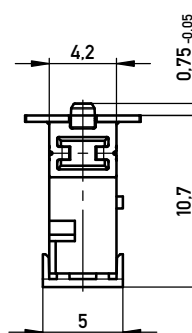
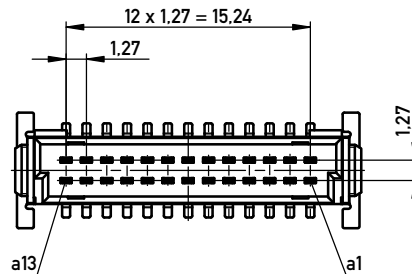




Leiterplatten-Layout Vorschlag für SMT PCB-Layout Proposal for SMT



ohne Ansaughaube - without hood



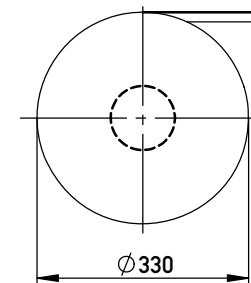
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

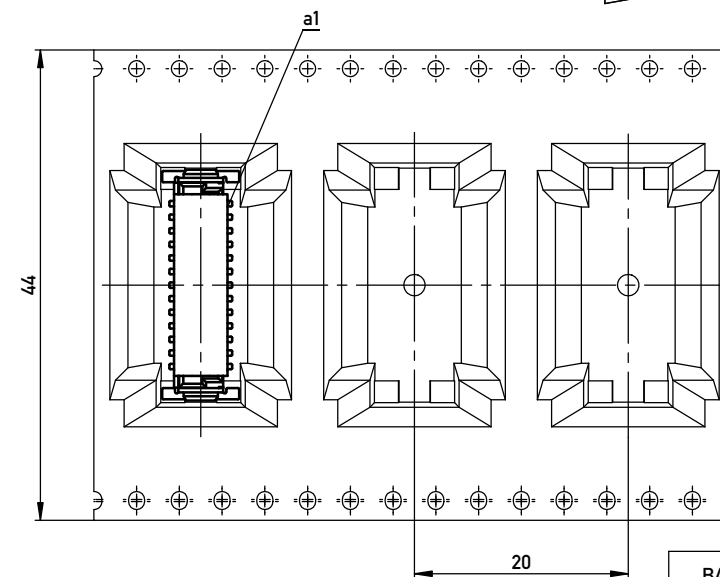
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 250 Stück
Packaging unit: 250 pcs



Abspulrichtung - Reel off Direction



BA 8-23 - hohe Bauhöhe
type 8-23 - High Profile

Proprietary notice pursuant to ISO 9001 to be observed.	Information:			Tolerances	 All Dimensions in mm	Scale	3:1		
	All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.			Subject to modification without prior notice. Drawing will not be updated.		Designation			
						Messerl. SMC-Q 26-SMD-BA8-23			
						Male SMC-Q 26-SMD-type8-23			
						234207			
e			26.06.2015			www.ERNI.com		I	
Index			Date				Class	SMCQ	A3

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